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Embedded - Microcontrollers - Application Specific: Tailored Solutions for Precision and Performance

Embedded - Microcontrollers - Application Specific

represents a category of microcontrollers designed with unique features and capabilities tailored to specific application needs. Unlike general-purpose microcontrollers, application-specific microcontrollers are optimized for particular tasks, offering enhanced performance, efficiency, and functionality to meet the demands of specialized applications.

What Are <u>Embedded - Microcontrollers -</u> <u>Application Specific</u>?

Application enacific microcontrollars are angineered to

Details

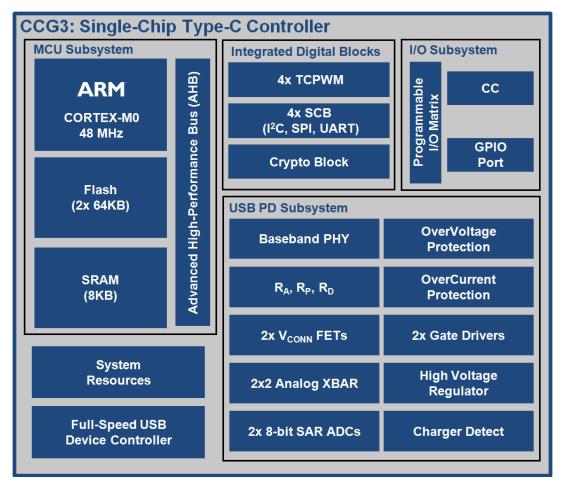
Details	
Product Status	Active
Applications	USB Type C
Core Processor	ARM® Cortex®-M0
Program Memory Type	FLASH (128kB)
Controller Series	-
RAM Size	8K x 8
Interface	I ² C, SPI, UART/USART, USB
Number of I/O	20
Voltage - Supply	2.7V ~ 5.5V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	40-UFQFN Exposed Pad
Supplier Device Package	40-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cypd3135-40lqxi

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



Logic Block Diagram





EZ-PD™ CCG3

Contents

EZ-PD CCG3 Block Diagram	4
Functional Overview	5
CPU and Memory Subsystem	5
Crypto Block	
Integrated Billboard Device	5
USB-PD Subsystem (USBPD SS)	
Full-Speed USB Subsystem	
Peripherals	6
GPIO	7
Power Systems Overview	8
Pinouts	9
Available Firmware and Software Tools	13
EZ-PD Configuration Utility	13
CCG3 Programming and Bootloading	
Programming the Device Flash over SWD	
Interface	14
Application Firmware Update over Specific	
Interfaces (I2C, CC, USB)	14
Applications	

Electrical Specifications	23
Absolute Maximum Ratings	23
Device-Level Specifications	24
Digital Peripherals	26
System Resources	28
Ordering Information	34
Ordering Code Definitions	34
Packaging	35
Acronyms	38
Document Conventions	39
Units of Measure	39
References and Links to Applications Collaterals	40
Document History Page	41
Sales, Solutions, and Legal Information	45
Worldwide Sales and Design Support	45
Products	
PSoC® Solutions	45
Cypress Developer Community	45
Technical Support	45





Pinouts

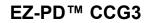
Table 2. CCG3 Pin Description for 42-CSP, 32-QFN and 40-QFN Devices

Pin Map 42-CSP	Pin Map 32-QFN	Pin Map 40-QFN	Name	Description
A5	N/A	1	VBUS_P_CTRL1	VBUS Gate Driver Control 1 for Producer Switch
A6	1	2	VBUS_P_CTRL0	VBUS Gate Driver Control 0 for Producer Switch
B6	2	3	CC2	USB PD connector detect/Configuration Channel 2
C5	N/A	N/A	CC2	USB PD connector detect/Configuration Channel 2
D4	3	4	V5V	5.0V – 5.5V supply for VCONN FETs
C6	4	5	CC1	USB PD connector detect/Configuration Channel 1
D6	N/A	N/A	CC1	USB PD connector detect/Configuration Channel 1
E6	N/A	6	VCONN	VCONN Input - provides Ra termination for cable applications
F6	5	7	P1.0	GPIO/UART_2_TX / SPI_2_MISO
D5	N/A	8	P1.1	GPIO/UART_2_RX / SPI_2_SEL
E5	6	9	P1.2	GPIO/UART_0_RX/ UART_3_CTS/ SPI_3_MOSI/ I2C_3_SCL / HPD
G6	7	10	P1.3	GPIO/UART_0_TX/ UART_3_RTS/ SPI_3_CLK/ I2C_3_SDA
E4	N/A	11	AUX_P / P1.6	DisplayPort AUX_P signal / GPIO / UART_1_TX / SPI_1_MISO
F5	8	12	SBU1 / P1.4	USB Type-C SBU1 signal / GPIO / UART_3_TX/ SPI_3_MISO/ SWD_1_CLK
G5	9	13	SBU2 / P1.5	USB Type-C SBU2 signal / GPIO / UART_3_RX/ SPI_3_SEL/ SWD_1_DAT
G4	N/A	14	AUX_N / P1.7	DisplayPort AUX_N signal / GPIO / UART_1_RX / SPI_1_SEL
F4	10	15	P2.0	GPIO / UART_1_CTS / SPI_1_CLK/ I2C_1_SCL / SWD_0_DAT
G3	11	16	P2.1	GPIO / UART_1_RTS / SPI_1_MOSI/ I2C_1_SDA / SWD_0_CLK
G2	13	17	VDDD	VDDD Supply Input / Output (2.7 V–5.5 V)
F3	14	18	VDDIO	1.71 V–5.5 V supply for I/Os. This supply also powers the global analog multiplex buses.
F2	15	19	VCCD	1.8V regulator output for filter capacitor
G1	16	20	VSYS	System Power Supply (2.7 V–5.5 V)
F1	17	21	DPLUS	USB 2.0 DP
E1	18	22	DMINUS	USB 2.0 DM
E2	19	23	P2.4	GPIO
D3	20	24	P2.5	GPIO / UART_0_TX/ SPI_0_MOSI
D2	N/A	25	P2.6	GPIO / UART_0_RX/ SPI_0_CLK
D1	21	26	XRES	External Reset Input. Internally pulled-up to VDDIO.
C3	22	27	P0.0	I2C_0_SDA / GPIO_OVT / UART_0_CTS / SPI_0_SEL/ TCPWM0
C2	23	28	P0.1	I2C_0_SCL / GPIO_OVT / UART_0_RTS / SPI_0_MISO/ TCPWM1



Pin Map 42-CSP	Pin Map 32-QFN	Pin Map 40-QFN	Name	Description
C1	N/A	29	VBUS_C_CTRL1	VBUS Gate Driver Control 1 for Consumer Switch
C4	24	30	VBUS_C_CTRL0	VBUS Gate Driver Control 0 for Consumer Switch
B1	25	31	VBUS	VBUS Input
A1	26	32	VBUS_DISCHARGE	VBUS Discharge Control output
E3	12, 27	33	VSS	Cround Supply (CND)
E3	EPAD	EPAD	VSS	Ground Supply (GND)
A2	28	34	P3.2	GPIO / TCPWM0
B2	N/A	35	P3.3	GPIO / TCPWM1
В3	29	36	P3.4	GPIO / UART_2_CTS / SPI_2_MOSI/ I2C_2_SDA / TCPWM2
A3	30	37	P3.5	GPIO / UART_2_RTS / SPI_2_CLK/ I2C_2_SCL / TCPWM3
B4	N/A	38	P3.6	GPIO
A4	31	39	OC	Over-current Sensor Input
B5	32	40	VBUS_P	VBUS Producer Input

Table 2. CCG3 Pin Description for 42-CSP, 32-QFN and 40-QFN Devices (continued)





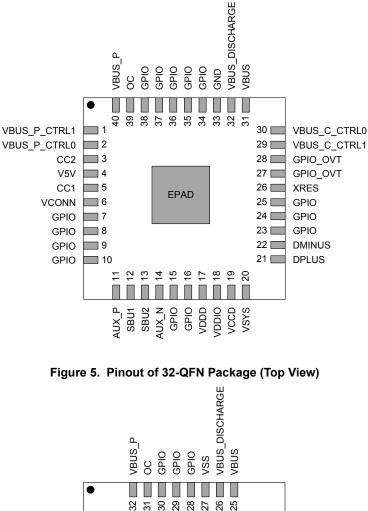
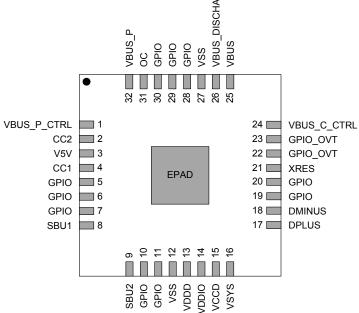


Figure 4. Pinout of 40-QFN Package (Top View)







Available Firmware and Software Tools

EZ-PD Configuration Utility

The EZ-PD Configuration Utility is a GUI-based Microsoft Windows application developed by Cypress to guide a CCGx user through the process of configuring and programming the chip. The utility allows users to:

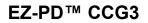
1. Select and configure the parameters they want to modify

2. Program the resulting configuration onto the target CCGx device.

The utility works with the Cypress supplied CCG1, CCG2, CCG3, and CCG4 kits, which host the CCGx controllers along with a USB interface. This version of the EZ-PD Configuration Utility supports configuration and firmware update operations on CCGx controllers implementing EMCA and Display Dongle applications. Support for other applications, such as Power Adapters and Notebook port controllers, will be provided in later versions of the utility.

You can download the EZ-PD Configuration Utility and its associated documentation at the following link:

http://www.cypress.com/documentation/software-and-drivers/ez-pd-configuration-utility





CCG3 Programming and Bootloading

There are two ways to program application firmware into a CCG3 device:

- 1. Programming the device flash over SWD Interface
- 2. Application firmware update over specific interfaces (CC, USB, I²C)

Generally, the CCG3 devices are programmed over SWD interface only during development or during the manufacturing process of the end product. Once the end product is manufactured, the CCG3 device's application firmware can be updated via the appropriate bootloader interface.

Programming the Device Flash over SWD Interface

CCG3 family of devices can be programmed using the SWD interface. Cypress provides a programming kit (CY8CKIT-002 MiniProg3 Kit) called MiniProg3 which can be used to program the flash as well as debug firmware. The flash is programmed by downloading the information from a hex file. This hex file is a binary file generated as an output of building the firmware project in PSoC Creator Software. Click here for more information on how to use the MiniProg3 programmer. There are many third party programmers that support mass programming in a manufacturing environment. As shown in the block diagram in Figure 7, the SWD_0_DAT and SWD_0_CLK pins are connected to the host programmer's SWDIO (data) and SWDCLK (clock) pins respectively. During SWD programming, the device can be powered by the host programmer by connecting its VTARG (power supply to the target device) to VSYS pin of CCG3 device. If the CCG3 device is powered using an on-board power supply, it can be programmed using the "Reset Programming" option. For more details, refer to the CYPD3XXX Programming Specifications.

The CYPD3105 device for Thunderbolt cable applications is pre-programmed with a micro-bootloader that allows users to program the flash using the alternate SWD pins (SBU1 for SWD_1_CLK and SBU2 for SWD_1_DAT) that can be connected to the SBU interface of a Type-C connector. Note that this interface can be used to program the flash only once. Subsequent re-programming of this device can be done through the primary SWD interface (SWD_0_CLK and SWD_0_DAT pins). Irrespective of which SWD interface is used for programming the device, once the device is programmed with the hex file provided by Cypress for thunderbolt cable application, subsequent updates to the application firmware can be done over the CC line. Refer to Application Firmware Update over Specific Interfaces (I2C, CC, USB) for more details.

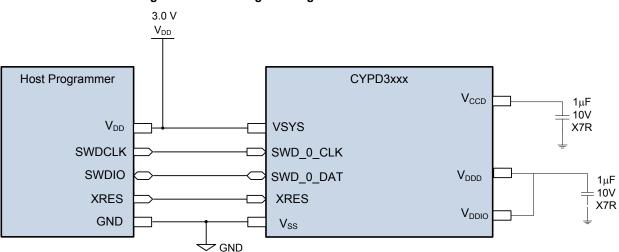


Figure 7. Connecting the Programmer to CYPD3xxx Device

Application Firmware Update over Specific Interfaces (I²C, CC, USB)

The application firmware can be updated over three different interfaces depending on the default firmware programmed into the CCG3 device. Refer to Table 38 for more details on default firmware that various part numbers of the CCG3 family of devices are pre-programmed with (Note that some of the devices have bootloader only and some have bootloader plus application firmware). The application firmware provided by Cypress for all CCG3 applications have dual images. This allows fail-safe update of the alternate image while executing from the current image. For more information, refer to the EZ-PD Configuration Utility User Manual.

Application Firmware Update over I²C Interface

This method primarily applies to CYPD3122, CYPD3125 and CYPD3126 devices of the CCG3 family. In these applications, the CCG3 device interfaces to an on-board application processor or an embedded controller over I²C interface. Refer to Figure 8 for more details. Cypress provides pseudo-code for the host processor for updating the CCG3 device firmware.





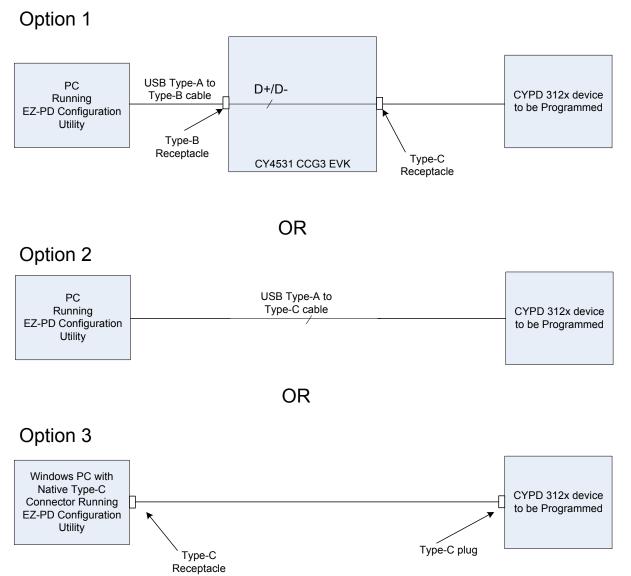




Figure 12 illustrates a power bank application diagram using a CCG3 device. In this application, the Type-C receptacle is used for providing as well as consuming power. The consumer path will be active when the battery is charged using a Type-C power source that is connected to the Type-C receptacle in Figure 12. The provider path will be active when the power bank is used for providing power to a sink device connected to the Type-C receptacle. Additionally, a Type-A receptacle can also be provided for providing power to the sinks that have a legacy USB interface.

The CCG3 device negotiates power contracts between the power bank and the sink/source device connected to the Type-C receptacle. The CCG3 device also controls and drives the provider and consumer path FETs and can monitor overcurrent and overvoltage conditions on the Type-C VBUS line.

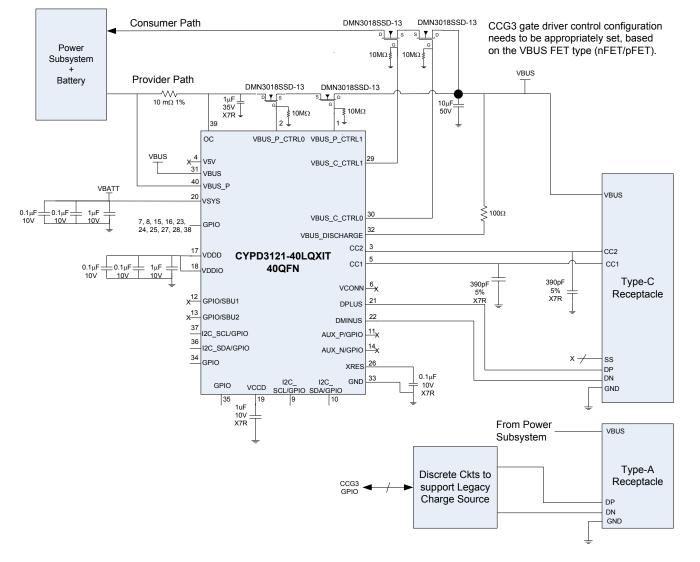


Figure 12. Power Bank Application Diagram (40-QFN Device)



Figure 13 illustrates a USB Type-C to DisplayPort (4-lane) adapter application, which enables connectivity between a PC that supports a Type-C port with DisplayPort Alternate Mode support and a legacy monitor that has a DisplayPort interface.

The application meets the requirements described in Section 4.2 of the VESA DisplayPort Alt Mode on USB Type-C Standard Version 1.0 (Scenarios 2a and 2b USB Type-C to DisplayPort Cables).

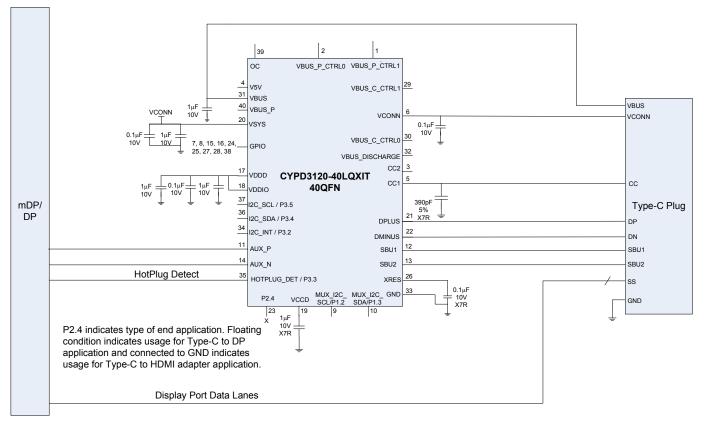


Figure 13. USB Type-C to DisplayPort Adapter Application Diagram



I^2C

Table 10. Fixed I²C DC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID149	I _{I2C1}	Block current consumption at 100 kHz	-	-	60	μA	-
SID150	I _{I2C2}	Block current consumption at 400 kHz	-	-	185	μA	-
SID151	I _{I2C3}	Block current consumption at 1 Mbps	-	-	390	μA	-
SID152	I _{I2C4}	I ² C enabled in Deep Sleep mode	-	-	1.4	μA	-

Table 11. Fixed I²C AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID153	F _{I2C1}	Bit rate	Ι	1	1	Mbps	_

Table 12. Fixed UART DC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID160	I _{UART1}	Block current consumption at 100 Kb/s	-	-	125	μA	-
SID161	I _{UART2}	Block current consumption at 1000 Kb/s	-	Ι	312	μA	_

Table 13. Fixed UART AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID162	F _{UART}	Bit rate	-	-	1	Mbps	_

Table 14. Fixed SPI DC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID163	I _{SPI1}	Block current consumption at 1 Mb/s	-	-	360	μA	-
SID164	I _{SPI2}	Block current consumption at 4 Mb/s	-	-	560	μA	-
SID165	I _{SPI3}	Block current consumption at 8 Mb/s	-	-	600	μA	-

Table 15. Fixed SPI AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID166	Len	SPI Operating frequency (Master; 6X oversampling)	_	-	8	MHz	-

Table 16. Fixed SPI Master Mode AC Specifications

(Guaranteed by Characterization)

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID167	T _{DMO}	MOSI Valid after SClock driving edge	-	-	15	ns	-
SID168	T _{DSI}	MISO Valid before SClock capturing edge	20	-	-		Full clock, late MISO sampling
SID169	т _{нмо}	Previous MOSI data hold time	0	I	_	ne	Referred to slave capturing edge



Internal Main Oscillator

Table 21. IMO DC Specifications

(Guaranteed by Design)

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID218	I _{IMO1}	IMO operating current at 48 MHz	-	-	1000	μA	-

Table 22. IMO AC Specifications

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID.CLK#13	F _{IMOTOL}	Frequency variation at 24, 36, and 48 MHz (trimmed)	-	-	±2	%	–25 °C \leq T _A \leq 85 °C, all VDDD
SID226	T _{STARTIMO}	IMO start-up time	-	-	7	μs	Guaranteed by characterization
SID229	T _{JITRMSIMO2}	RMS jitter at 24 MHz	_	145	-	ps	Guaranteed by characterization
SID.CLK#1	F _{IMO}	IMO frequency	24	-	48	MHz	All VDDD

Internal Low-Speed OscillatorPower Down

Table 23. ILO DC Specifications

(Guaranteed by Design)

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID231	I _{ILO1}	I _{LO} operating current	-	0.3	1.05	μA	-
SID233	IILOLEAK	I _{LO} leakage current	1	2	15	nA	_

Table 24. ILO AC Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID234	T _{STARTILO1}	I _{LO} start-up time	-	-	2	me	Guaranteed by characterization
SID238	T _{ILODUTY}	I _{LO} duty cycle	40	50	60	%	Guaranteed by characterization
SID.CLK#5	F _{ILO}	I _{LO} frequency	20	40	80	kHz	_

Table 25. PD DC Specifications

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SID.PD.1	Rp_std	DFP CC termination for default USB Power	64	80	96	μA	-
SID.PD.2	Rp_1.5A	DFP CC termination for 1.5A power	166	180	194.4	μA	-
SID.PD.3	Rp_3.0A	DFP CC termination for 3.0A power	304	330	356.4	μA	-
SID.PD.4	Rd	UFP CC termination	4.59	5.1	5.61	kΩ	-
SID.PD.5	Rd_DB	UFP Dead Battery CC termination on CC1 and CC2, valid for 1.5A and 3.0A Rp termination values	4.08	5.1	6.12	kΩ	UFP Dead Battery CC termination on CC1 and CC2. For Default Rp termination, the voltage on CC1 and CC2 is guaranteed to be <1.32 V.
SID.PD.6	R _A	EMCA cable termination	0.8	1.0	1.2	kΩ	All supplies forced to 0 V and 0.2 V applied at VCONN.
SID.PD.7	Ra_OFF	EMCA cable termination - Disabled	0.4	0.75	_	MΩ	2.7 V applied at VCONN with R _A disabled.



Table 29. Gate Driver AC Specifications

Spec ID	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
AC.NGDO.1	T _{ON}	Gate turn-on time to gate_driver_supply_voltage + 5V for supply voltage \ge 5V and VBUS * 2 for supply voltage < 5V	Ι	_	1	ms	 Gate driver configuration = NFET Load = The gate of a SI9936 MOSFET

SBU

Table 30. Analog Crossbar Switch Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID.SBU.1	Ron_sw	Switch ON Resistance	-	-	10	Ω	Voltage input from 0 V to 3.6 V
SID.SBU.2	Rpu_aux_1	AUX_P/N Pull-up Resistance – 100k	80	_	120	kΩ	-
SID.SBU.3	Rpu_aux_2	AUX_P/N Pull-up Resistance – 1M	0.8	_	1.2	MΩ	-
SID.SBU.4	Rpd_aux_1	AUX_P/N Pull-down Resistance – 100k	80	_	120	kΩ	-
SID.SBU.5	Rpd_aux_2	AUX_P/N Pull-down Resistance – 1M	0.8	_	1.2	MΩ	-
SID.SBU.6	Rpd_aux_3	AUX_P/N Pull-down Resistance – 470k	329	_	611	kΩ	-
SID.SBU.7	Rpd_aux_4	AUX_P/N Pull-down Resistance – 4.7M	3.29	-	6.11	MΩ	-

Charger Detect

Table 31. Charger Detect Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID.CD.1	VDAT_REF	BC1.2 Data Detect Voltage Threshold	250	-	400	mV	-
SID.CD.2	VDM_SRC	BC1.2 DM Voltage Source	500	-	700	mV	With current sink of 25 μΑ–175 μΑ
SID.CD.3	VDP_SRC	BC1.2 DP Voltage Source	500	-	700	mV	With current sink of 25 μΑ–175 μΑ
SID.CD.4	IDM_SINK	BC1.2 DM Current Sink	25	-	175	μA	-
SID.CD.5	IDP_SINK	BC1.2 DP Current Sink	25	-	175	μA	-
SID.CD.6	IDP_SRC	BC1.2 DP DCD Current Source	7	-	13	μA	-
SID.CD.7	RDP_UP	USB FS DP Pull-up Termination	0.9	-	1.575	kΩ	-
SID.CD.8	RDM_UP	USB FS DM Pull-up Termination	0.9	-	1.575	kΩ	-
SID.CD.9	RDP_DWN	USB FS DP Pull-down Termination	14.25	-	24.8	kΩ	-
SID.CD.10	RDM_DWN	USB FS DM Pull-down Termination	14.25	-	24.8	kΩ	-
SID.CD.11	RDAT_LKG	DP/DM Data Line Leakage Termination	300	-	500	kΩ	The charger detect function and data line leakage is enabled.
SID.CD.12	RDCP_DAT	BC1.2 DCP Port Resistance between DP and DM	-	-	40	Ω	_
SID.CD.13	VSETH	USB FS Logic Threshold	1.26	-	1.54	V	-



Memory

Table 37. Flash AC Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID.MEM#3	FLASH_ERASE	Row erase time	-	Ι	15.5	ms	_
SID.MEM#4	FLASH_WRITE	Row (Block) write time (erase and program)	-	-	20	ms	_
SID.MEM#8	FLASH_ROW_PGM	Row program time after erase	-	-	7	ms	_
SID178	TBULKERASE	Bulk erase time (64k Bytes)	_	_	35	ms	_
SID180	TDEVPROG	Total device program time	_	-	7.5	S	Guaranteed by characterization
SID182	FRET1	Flash retention, T _A ≤ 55 °C, 100 K P/E cycles	20	-	-	years	Guaranteed by characterization
SID182A	FRET2	Flash retention, T _A ≤ 85 °C, 10 K P/E cycles	10	-	-	years	Guaranteed by characterization
SID182B	FRET3	Flash retention, T _A ≤ 105 °C, 10 K P/E cycles	3	-	-	years	Guaranteed by characterization





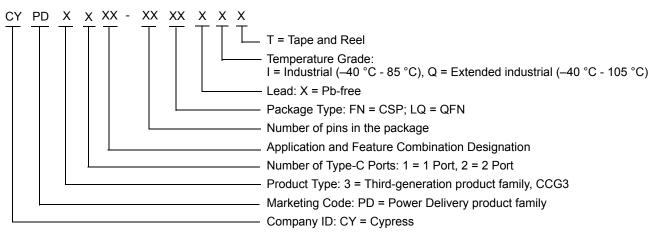
Ordering Information

Table 38 lists the EZ-PD CCG3 part numbers and features.

Table 38. EZ-PD CCG3 Ordering Information

Part Number	Application	Termination Resistor	Role	Default FW	Package	Si ID
CYPD3120-40LQXIT	Dongle	R _P , R _D ^[4] , R _{D_DB}	UFP	USB Bootloader and Application FW	40-QFN	1D00
CYPD3121-40LQXIT	Power Banks	R _P ^[5] , R _D , R _{D_DB} ^[6]	DRP	USB Bootloader	40-QFN	1D02
CYPD3122-40LQXIT	Monitor (DFP)	R _P , R _D , R _{D_DB}	DFP	I ² C Bootloader	40-QFN	1D03
CYPD3123-40LQXIT	Charge-through Dongle	R _P , R _D , R _{D_DB}	DRP	USB Bootloader and Application FW	40-QFN	1D09
CYPD3125-40LQXIT	Notebooks, Smartphones	R _P , R _D , R _{D_DB}	DRP	I ² C Bootloader	40-QFN	1D04
CYPD3126-42FNXIT	DRP	R _P , R _D ^[4] , R _{D_DB}	DRP	I ² C Bootloader	42-CSP	1D07
CYPD3135-32LQXQT	Power Adapter	R _P	DFP	CC Bootloader and Application FW	32-QFN	1D08
CYPD3135-40LQXIT	Power Adapter	R _P	DFP	CC Bootloader and Application FW	40-QFN	1D05
CYPD3135-40LQXQT	Power Adapter	R _P	DFP	CC Bootloader and Application FW	40-QFN	1D05

Ordering Code Definitions



- Notes
 3. Termination resistor denoting an EMCA.
 4. Termination resistor denoting an upstream facing port.
 5. Termination resistor denoting a downstream facing port.
 6. Termination resistor denoting dead battery termination.



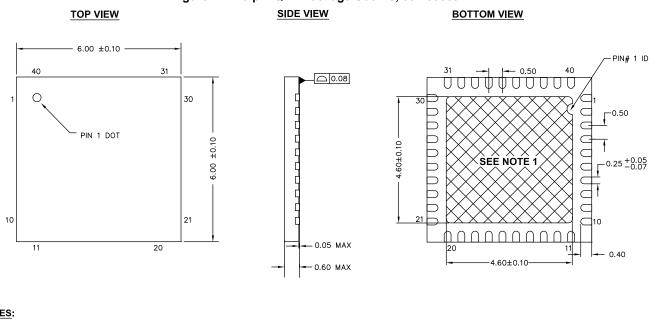


Figure 17. 40-pin QFN Package Outline, 001-80659

NOTES:

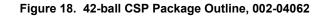
1. XXX HATCH AREA IS SOLDERABLE EXPOSED PAD

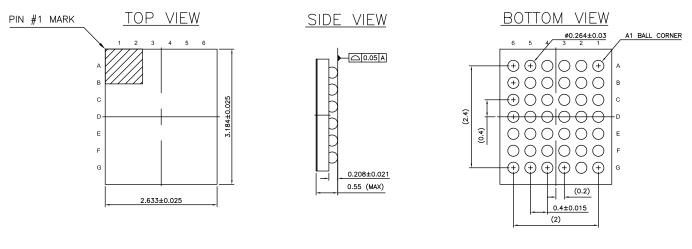
2. REFERENCE JEDEC # MO-248

3. PACKAGE WEIGHT: 68 ±2 mg

4. ALL DIMENSIONS ARE IN MILLIMETERS

001-80659 *A





002-04062 *A

ALL DIMENSIONS ARE IN MM JEDEC Publication 95, Design Guide 4.18



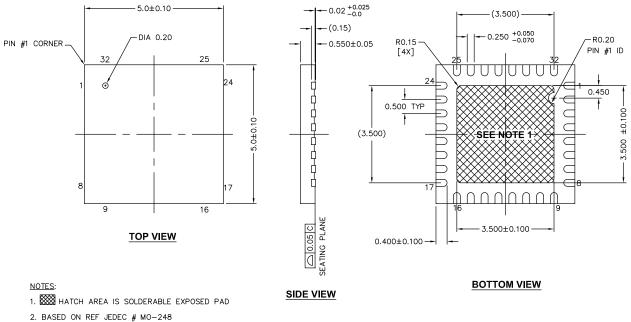


Figure 19. 32-pin QFN Package Outline, 001-42168

3. PACKAGE WEIGHT: 0.0388g

4. DIMENSIONS ARE IN MILLIMETERS

001-42168 *E



Document Conventions

Units of Measure

Table 43. Units of Measure

Symbol	Unit of Measure
°C	degrees Celsius
Hz	hertz
KB	1024 bytes
kHz	kilohertz
kΩ	kilo ohm
Mbps	megabits per second
MHz	megahertz
MΩ	mega-ohm
Msps	megasamples per second
μA	microampere
μF	microfarad
μs	microsecond
μV	microvolt
μW	microwatt
mA	milliampere
ms	millisecond
mV	millivolt
nA	nanoampere
ns	nanosecond
Ω	ohm
pF	picofarad
ppm	parts per million
ps	picosecond
s	second
sps	samples per second
V	volt





References and Links to Applications Collaterals

Knowledge Base Articles

- Key Differences Among EZ-PD[™] CCG1, CCG2, CCG3 and CCG4 KBA210740
- Programming EZ-PD[™] CCG2, EZ-PD[™] CCG3 and EZ-PD[™] CCG4 Using PSoC® Programmer and MiniProg3 KBA96477
- CCGX Frequently Asked Questions (FAQs) KBA97244
- Handling Precautions for CY4501 CCG1 DVK KBA210560
- Cypress EZ-PD[™] CCGx Hardware KBA204102
- Difference between USB Type-C and USB-PD KBA204033
- CCGx Programming Methods KBA97271
- Getting started with Cypress USB Type-C Products -KBA04071
- Type-C to DisplayPort Cable Electrical Requirements
- Dead Battery Charging Implementation in USB Type-C Solutions - KBA97273
- Termination Resistors Required for the USB Type-C Connector – KBA97180
- VBUS Bypass Capacitor Recommendation for Type-C Cable and Type-C to Legacy Cable/Adapter Assemblies – KBA97270
- Need for Regulator and Auxiliary Switch in Type-C to DisplayPort (DP) Cable Solution - KBA97274
- Need for a USB Billboard Device in Type-C Solutions KBA97146
- CCG1 Devices in Type-C to Legacy Cable/Adapter Assemblies - KBA97145
- Cypress USB Type-C Controller Supported Solutions KBA97179
- Termination Resistors for Type-C to Legacy Ports KBA97272
- Handling Instructions for CY4502 CCG2 Development Kit KBA97916
- Thunderbolt[™] Cable Application Using CCG3 Devices KBA210976
- Power Adapter Application Using CCG3 Devices KBA210975
- Methods to Upgrade Firmware on CCG3 Devices KBA210974
- Device Flash Memory Size and Advantages KBA210973
- Applications of EZ-PD[™] CCG4 KBA210739

Application Notes

AN96527 - Designing USB Type-C Products Using Cypress's CCG1 Controllers

- AN95615 Designing USB 3.1 Type-C Cables Using EZ-PD™ CCG2
- AN95599 Hardware Design Guidelines for EZ-PD[™] CCG2
- AN210403 Hardware Design Guidelines for Dual Role Port Applications Using EZ-PD[™] USB Type-C Controllers
- AN210771 Getting Started with EZ-PD[™] CCG4

Reference Designs

- EZ-PD[™] CCG2 Electronically Marked Cable Assembly (EMCA) Paddle Card Reference Design
- EZ-PD[™] CCG2 USB Type-C to DisplayPort Cable Solution
- CCG1 USB Type-C to DisplayPort Cable Solution
- CCG1 USB Type-C to HDMI/DVI/VGA Adapter Solution
- EZ-PD[™] CCG2 USB Type-C to HDMI Adapter Solution
- CCG1 Electronically Marked Cable Assembly (EMCA) Paddle Card Reference Design
- CCG1 USB Type-C to Legacy USB Device Cable Paddle Card Reference Schematics
- EZ-USB GX3 USB Type-C to Gigabit Ethernet Dongle
- EZ-PD[™] CCG2 USB Type-C Monitor/Dock Solution
- CCG2 20W Power Adapter Reference Design
- CCG2 18W Power Adapter Reference Design
- EZ-USB GX3 USB Type-A to Gigabit Ethernet Reference Design Kit

Kits

- CY4501 CCG1 Development Kit
- CY4502 EZ-PD[™] CCG2 Development Kit
- CY4531 EZ-PD CCG3 Evaluation Kit
- CY4541 EZ-PD[™] CCG4 Evaluation Kit

Datasheets

- CCG1 Datasheet: USB Type-C Port Controller with Power Delivery
- CYPD1120 Datasheet: USB Power Delivery Alternate Mode Controller on Type-C
- CCG2: USB Type-C Port Controller Datasheet
- CCG4: Two-Port USB Type-C Controller Datasheet



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